

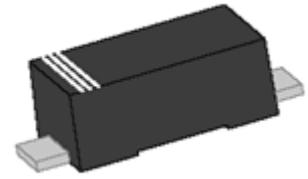


## SMFxxH Series 200W Transient Voltage Suppressor

Rev.1.3

### DESCRIPTION:

TVS diodes can be used in a wide range of applications which like consumer electronic products, automotive industries, munitions, telecommunications, aerospace industries, and intelligent control systems.



SOD-123FL



Bi-directional



Uni-directional

Symbol

### FEATURES:

- ✧ Low profile package.
- ✧ Low inductance.
- ✧ Excellent clamping capability.
- ✧ 200W peak pulse power capability at 10/1000μs waveform.
- ✧ Fast response time: typically less than 1.0ps from 0V to  $V_{BR}$  min.
- ✧ High temperature reflow soldering: 260°C/40s at terminals.
- ✧ Plastic package has underwriters laboratory flammability 94V-0.
- ✧ Meets MSL level 1, per J-STD-020, LF maximum peak of 260°C.
- ✧ Terminal: solder plated, solderable per J-STD-002.
- ✧ For surface mounted applications in order to optimize board space.
- ✧ High reliability application and automotive grade (AEC-Q101 qualified).

### ABSOLUTE MAXIMUM RATINGS( $T_A=25^{\circ}C$ , RH=45%-75%, unless otherwise noted)

Parameter	Symbol	Value	Unit
Storage and operating junction temperature range	$T_{STG}/T_J$	-55 to +150	°C
Peak pulse power dissipation at 10/1000μs waveform	$P_{PP}$	200	W
Maximum instantaneous forward voltage at 20A for unidirectional	$V_F$	3.5	V
Typical thermal resistance junction to lead	$R_{\theta JL}$	100	°C/W
Typical thermal resistance junction to ambient	$R_{\theta JA}$	220	°C/W

**MARKING**



5CH : Device Marking Code

**ELECTRICAL CHARACTERISTICS**( $T_A=25^{\circ}C$ )

Part Number	Marking	$V_R$	$I_R@V_R$	$V_{BR}@I_T$		$I_T$	$V_C@I_{PP}$	$I_{PP}^{①}$
		V	max( $\mu A$ )	min(V)	max(V)	mA	max(V)	A
SMF5.0AH	KEH	5.0	10	6.40	7.00	10	9.2	21.7
SMF5.0CAH	5CH	5.0	40	6.40	7.00	10	9.2	21.7
SMF6.0AH	KGH	6.0	10	6.67	7.37	10	10.3	19.4
SMF6.0CAH	6CH	6.0	40	6.67	7.37	10	10.3	19.4

① Surge waveform:10/1000 $\mu s$

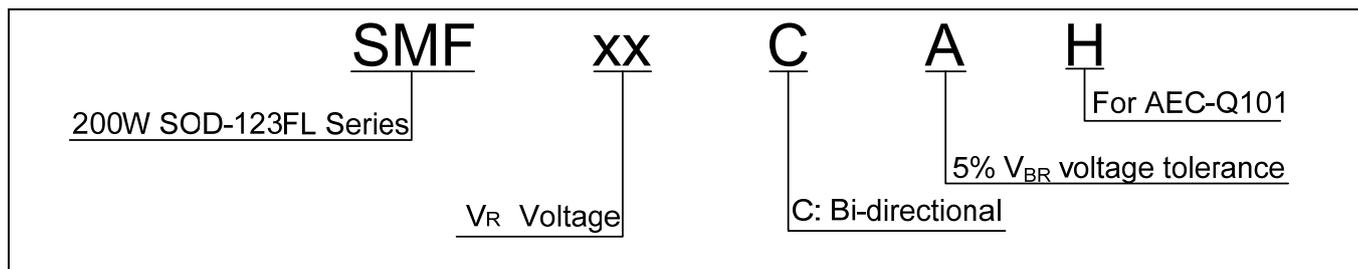
$V_R$ : Stand-off voltage -- maximum voltage that can be applied

$V_{BR}$ : Breakdown voltage

$V_C$ : Clamping voltage -- peak voltage measured across the suppressor at a specified  $I_{PP}$

$I_R$ : Reverse leakage current

**ORDERING INFORMATION**



RATINGS AND V-I CHARACTERISTICS CURVES (T<sub>A</sub>=25°C, unless otherwise noted)

FIG.1:V- I curve characteristics (Uni-directional)

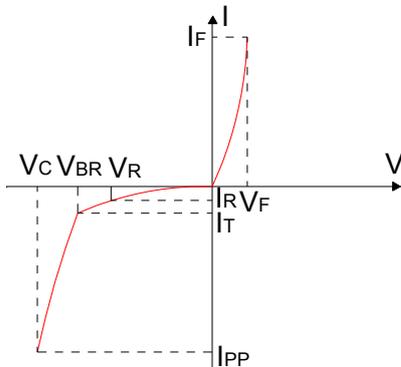


FIG.2:V- I curve characteristics (Bi-directional)

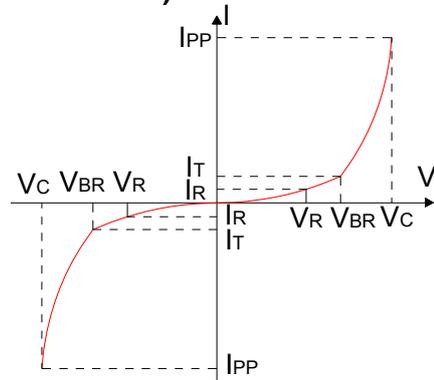


FIG.3: Pulse waveform

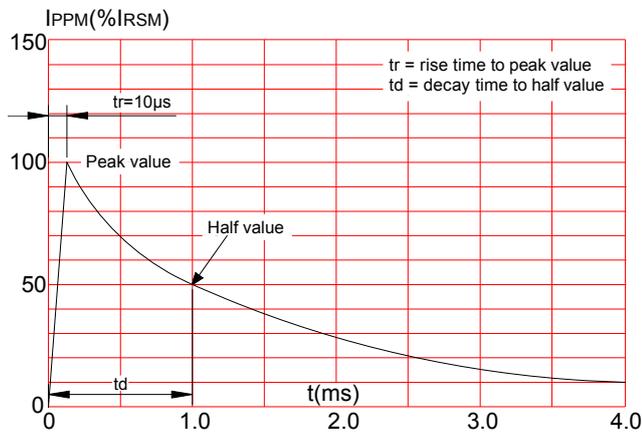
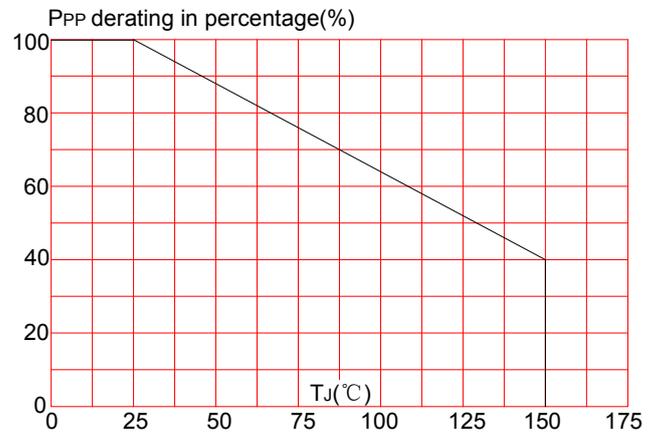
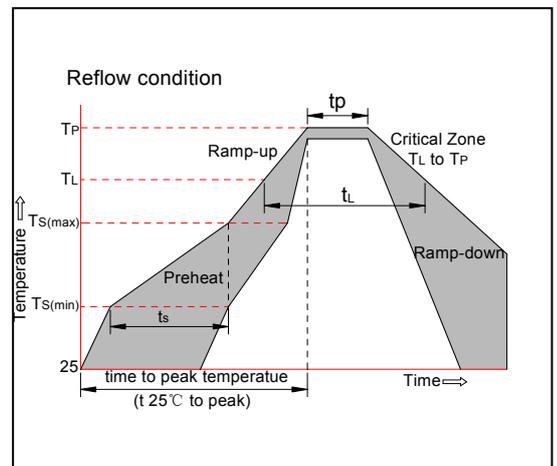


FIG.4: Pulse derating curve

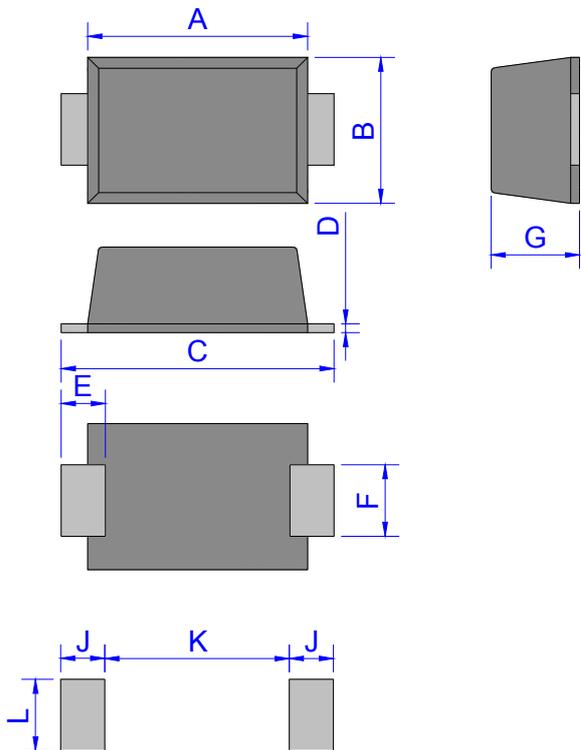


SOLDERING PARAMETERS

Reflow Condition		Pb-Free assembly (see figure at right)
Pre Heat	-Temperature Min (T <sub>S(min)</sub> )	+150°C
	-Temperature Max(T <sub>S(max)</sub> )	+200°C
	-Time (Min to Max) (ts)	60-180 secs.
Average ramp up rate (Liquidus Temp (T <sub>L</sub> )to peak)		3°C/sec. Max
T <sub>S(max)</sub> to T <sub>L</sub> - Ramp-up Rate		3°C/sec. Max
Reflow	-Temperature(T <sub>L</sub> )(Liquidus)	+217°C
	-Temperature(t <sub>L</sub> )	60-150 secs.
Peak Temp (T <sub>P</sub> )		+260(+0/-5)°C
Time within 5°C of actual Peak Temp (t <sub>p</sub> )		20-40secs.
Ramp-down Rate		6°C/sec. Max
Time 25°C to Peak Temp (T <sub>P</sub> )		8 min. Max
Do not exceed		+260°C



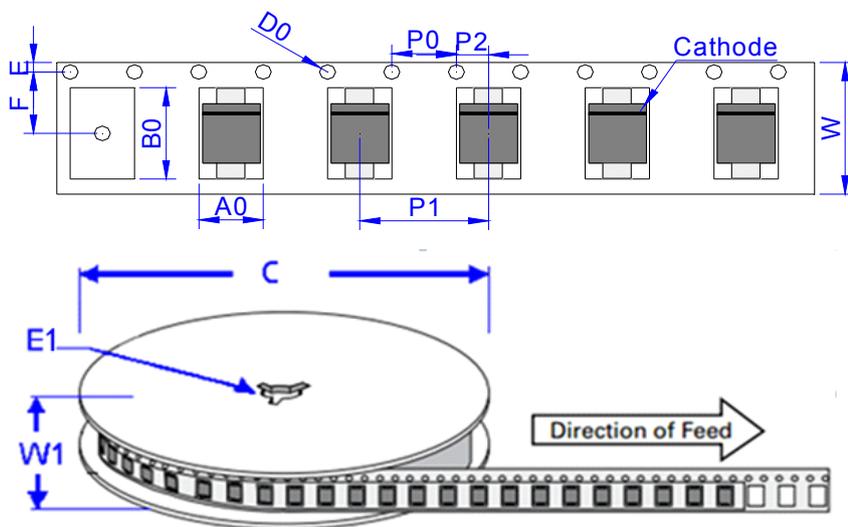
PACKAGE MECHANICAL DATA



SOD-123FL

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	2.60	3.00	0.102	0.118
B	1.60	2.00	0.063	0.079
C	3.45	3.95	0.136	0.156
D	0.10	0.25	0.004	0.01
E	0.3	0.9	0.012	0.035
F	0.80	1.20	0.031	0.047
G	0.95	1.35	0.037	0.053
J	1.30		0.051	
K		1.70		0.067
L	1.30		0.051	

TAPE AND REEL SPECIFICATION-SOD-123FL



Ref.	Dimensions	
	Millimeters	Inches
A0	1.95 ± 0.3	0.077 ± 0.012
B0	3.95 ± 0.3	0.156 ± 0.012
C	178	7.0
D0	1.55 ± 0.1	0.061 ± 0.004
E	1.75 ± 0.2	0.069 ± 0.008
E1	13.3 ± 0.3	0.524 ± 0.012
F	3.50 ± 0.2	0.138 ± 0.008
P0	4.00 ± 0.2	0.157 ± 0.008
P1	4.00 ± 0.2	0.157 ± 0.008
P2	2.00 ± 0.2	0.079 ± 0.008
W	8.0 ± 0.2	0.315 ± 0.008
W1	11.5 ± 1.0	0.453 ± 0.039

PART No.	UNIT WEIGHT (g/PCS) typ.	PACKAGE	REEL (PCS)	DESCRIPTION
SMFxxAH/CAH	0.0136	SOD-123FL	3000	7 inch reel pack

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